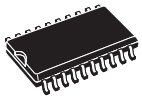
74VHC273

OCTAL D-TYPE FLIP FLOP WITH CLEAR

- HIGH SPEED:
  f_{MAX} = 165 MHz (TYP.) at V_{CC} = 5V
- LOW POWER DISSIPATION:
  I_{CC} = 4 µA (MAX.) at T_A=25°C
- HIGH NOISE IMMUNITY:
  $V_{NIH} = V_{NIL}$ = 28% V_{CC} (MIN.)
- POWER DOWN PROTECTION ON INPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:
  $|I_{OH}| = I_{OL}$ = 8 mA (MIN)
- BALANCED PROPAGATION DELAYS:
  $t_{PLH} \cong t_{PHL}$
- OPERATING VOLTAGE RANGE:
  V_{CC}(OPR) = 2V to 5.5V
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 273
- IMPROVED LATCH-UP IMMUNITY
- LOW NOISE: V_{OLP} = 0.9V (MAX.)



SOP



TSSOP

ORDER CODES

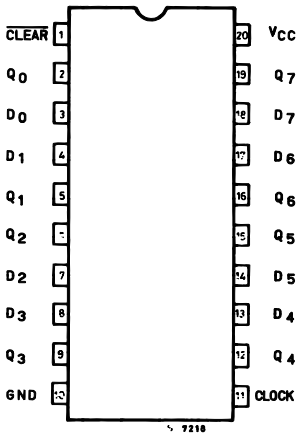
PACKAGE	TUBE	T & R
SOP	74VHC273M	74VHC273MTR
TSSOP		74VHC273TTR

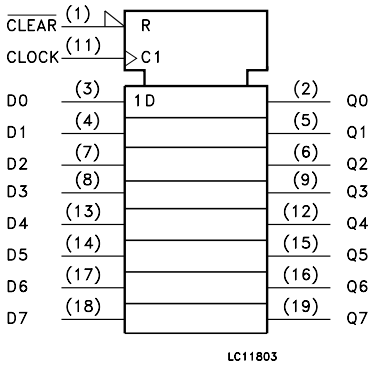
DESCRIPTION

The 74VHC273 is an advanced high-speed CMOS OCTAL D-TYPE FLIP FLOP WITH CLEAR fabricated with sub-micron silicon gate and double-layer metal wiring C^2MOS technology.
Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

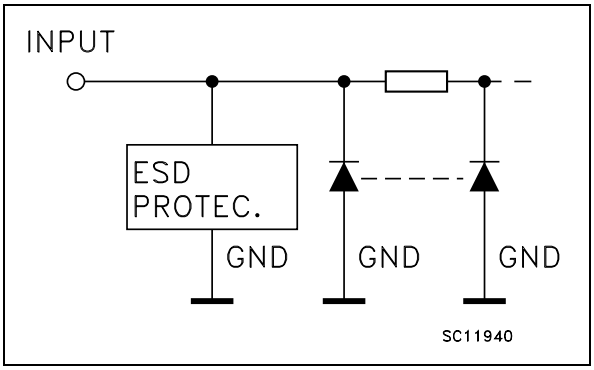
When the $\overline{\text{CLEAR}}$ input is held low, the Q outputs are held low independently of the other inputs.
Power down protection is provided on all inputs and 0 to 7V can be accepted on inputs with no regard to the supply voltage. This device can be used to interface 5V to 3V.
All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

PIN CONNECTION AND IEC LOGIC SYMBOLS





INPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

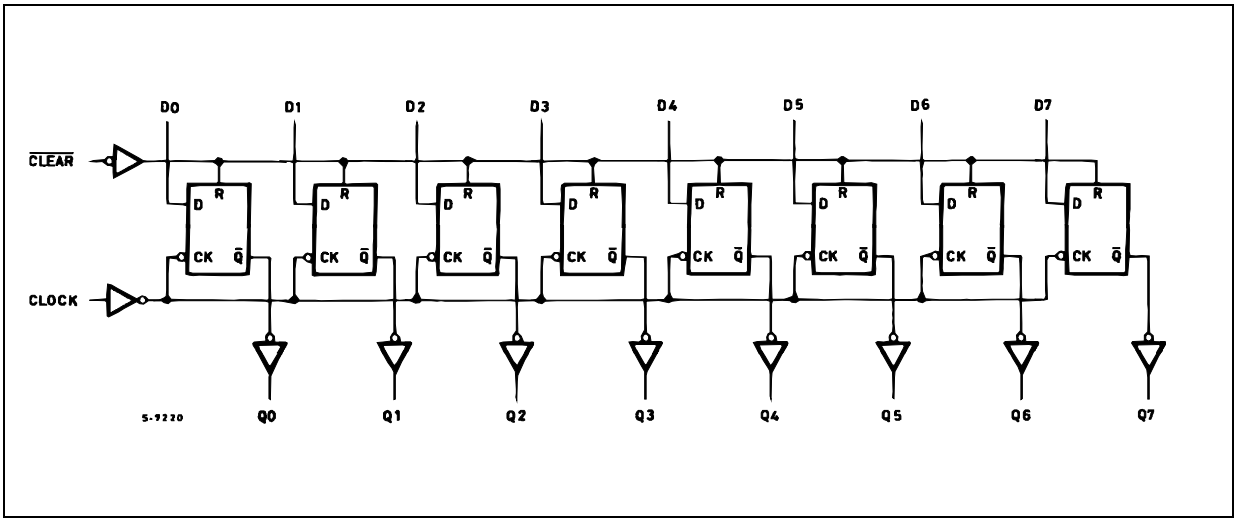
PIN No	SYMBOL	NAME AND FUNCTION
1	$\overline{\text{CLEAR}}$	Asynchronous Master Reset (Active LOW)
2, 5, 6, 9, 12, 15, 16,19	Q0 to Q7	Flip-Flop Outputs
3, 4, 7, 8, 13, 14, 17, 18	D0 to D7	Data Inputs
11	CLOCK	Clock Input (LOW-to-HIGH Edge Triggered)
10	GND	Ground (0V)
20	V_{CC}	Positive Supply Voltage

TRUTH TABLE

INPUTS			OUTPUT	FUNCTION
$\overline{\text{CLEAR}}$	D	B	Q	
L	X	X	L	CLEAR
H	L	⌐	L	
H	H	⌐	H	
H	X	¬	Q_n	NO CHANGE

X : Don't Care

LOGIC DIAGRAM



This logic diagram has not be used to estimate propagation delays

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	-0.5 to +7.0	V
V_I	DC Input Voltage	-0.5 to +7.0	V
V_O	DC Output Voltage	-0.5 to V_{CC} + 0.5	V
I_{IK}	DC Input Diode Current	- 20	mA
I_{OK}	DC Output Diode Current	± 20	mA
I_O	DC Output Current	± 25	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current	± 75	mA
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	2 to 5.5	V
V_I	Input Voltage	0 to 5.5	V
V_O	Output Voltage	0 to V_{CC}	V
T_{op}	Operating Temperature	-55 to 125	°C
dt/dv	Input Rise and Fall Time (note 1) (V_{CC} = 3.3 ± 0.3V) (V_{CC} = 5.0 ± 0.5V)	0 to 100 0 to 20	ns/V

1) V_{IN} from 30% to 70% of V_{CC}

DC SPECIFICATIONS

Symbol	Parameter	Test Condition		Value							Unit
		V_{CC} (V)		T_A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{IH}	High Level Input Voltage	2.0		1.5			1.5		1.5		V
		3.0 to 5.5		$0.7V_{CC}$			$0.7V_{CC}$		$0.7V_{CC}$		
V_{IL}	Low Level Input Voltage	2.0				0.5		0.5		0.5	V
		3.0 to 5.5				$0.3V_{CC}$		$0.3V_{CC}$		$0.3V_{CC}$	
V_{OH}	High Level Output Voltage	2.0	I_O=-50 µA	1.9	2.0		1.9		1.9		V
		3.0	I_O=-50 µA	2.9	3.0		2.9		2.9		
		4.5	I_O=-50 µA	4.4	4.5		4.4		4.4		
		3.0	I_O=-4 mA	2.58			2.48		2.4		
		4.5	I_O=-8 mA	3.94			3.8		3.7		
V_{OL}	Low Level Output Voltage	2.0	I_O=50 µA		0.0	0.1		0.1		0.1	V
		3.0	I_O=50 µA		0.0	0.1		0.1		0.1	
		4.5	I_O=50 µA		0.0	0.1		0.1		0.1	
		3.0	I_O=4 mA			0.36		0.44		0.55	
		4.5	I_O=8 mA			0.36		0.44		0.55	
I_I	Input Leakage Current	0 to 5.5	V_I = 5.5V or GND			± 0.1		± 1		± 1	µA
I_{CC}	Quiescent Supply Current	5.5	V_I = V_{CC} or GND			4		40		40	µA

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3ns$)

Symbol	Parameter	Test Condition			Value							Unit
		V_{CC} (V)	C_L (pF)		T_A = 25°C			-40 to 85°C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
t_{PLH} t_{PHL}	Propagation Delay Time CLOCK to Q	3.3(*)	15			8.7	13.6	1.0	16.0	1.0	16.0	ns
		3.3(*)	50			11.2	17.1	1.0	19.5	1.0	19.5	
		5.0(**)	15			5.8	9.0	1.0	10.5	1.0	10.5	
		5.0(**)	50			7.3	11.0	1.0	12.5	1.0	12.5	
t_{PHL}	Propagation Delay Time $\overline{\text{CLEAR}}$ to Q	3.3(*)	15			8.9	13.6	1.0	16.0	1.0	16.0	ns
		3.3(*)	50			11.4	17.1	1.0	19.5	1.0	19.5	
		5.0(**)	15			5.2	8.5	1.0	10.0	1.0	10.0	
		5.0(**)	50			6.7	10.5	1.0	12.0	1.0	12.0	
t_W	$\overline{\text{CLEAR}}$ Pulse Width LOW	3.3(*)					5.0		6.0		6.0	ns
		5.0(**)					5.0		5.0		5.0	
t_W	CLOCK Pulse Width HIGH or LOW	3.3(*)					5.5		6.5		6.5	ns
		5.0(**)					5.0		5.0		5.0	
t_s	Setup Time D to CLOCK, HIGH or LOW	3.3(*)					5.5		6.5		6.5	ns
		5.0(**)					4.5		4.5		4.5	
t_h	Hold Time D to CLOCK, HIGH or LOW	3.3(*)					1.0		1.0		1.0	ns
		5.0(**)					1.0		1.0		1.0	
t_{REM}	Removal Time $\overline{\text{CLEAR}}$ to CLOCK	3.3(*)					2.5		2.5		2.5	ns
		5.0(**)					2.0		2.0		2.0	
f_{MAX}	Maximum Clock Frequency	3.3(*)	15		75	120		65		65		MHz
		3.3(*)	50		50	75		45		45		
		5.0(**)	15		120	165		100		100		
		5.0(**)	50		80	110		70		70		
t_{OSLH} t_{OSHL}	Output to Output Skew time (note 1)	3.3(*)	50				1.5		1.5		1.5	ns
		5.0(**)	50				1.0		1.0		1.0	

(*) Voltage range is 3.3V ± 0.3V
(**) Voltage range is 5.0V ± 0.5V
Note 1 : Parameter guaranteed by design. $t_{soLH} = |t_{pLHm} - t_{pLHn}|$, $t_{soHL} = |t_{pHLm} - t_{pHLn}|$

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition	Value							Unit
			T_A = 25°C			-40 to 85°C		-55 to 125°C		
			Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
C_{IN}	Input Capacitance			7	10		10		10	pF
C_{PD}	Power Dissipation Capacitance (note 1)			31						pF

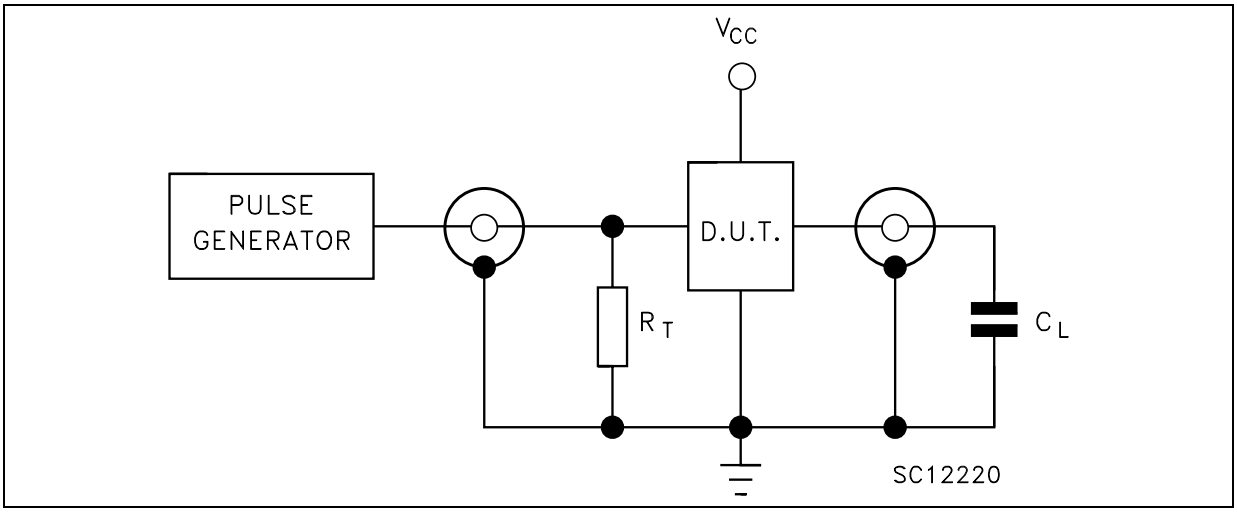
1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per Flip-Flop)

DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Condition		Value							Unit
		V_{CC} (V)		T_A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{OLP}	Dynamic Low Voltage Quiet Output (note 1, 2)	5.0	C_L = 50 pF		0.6	0.9					V
V_{OLV}				-0.9	-0.6						
V_{IHD}	Dynamic High Voltage Input (note 1, 3)	5.0		3.5							V
V_{ILD}	Dynamic Low Voltage Input (note 1, 3)	5.0				1.5					V

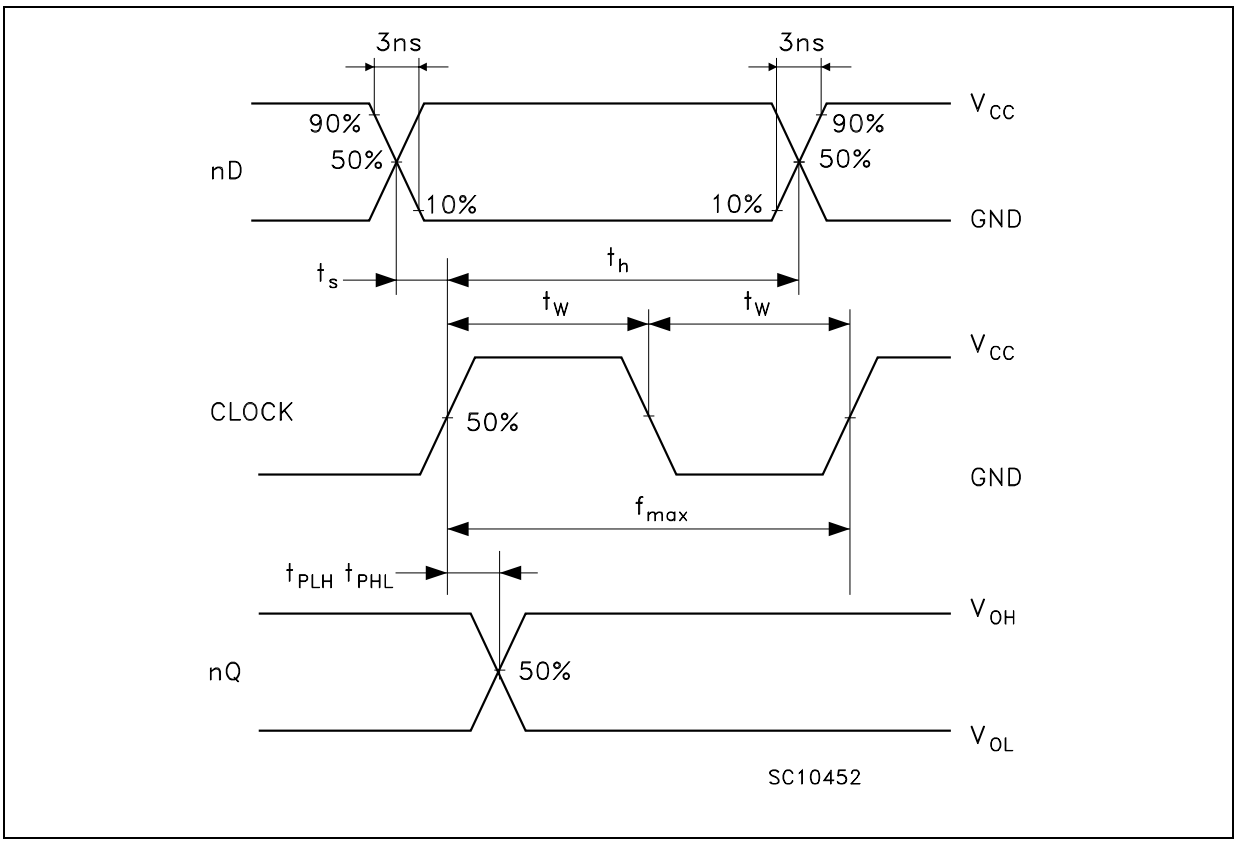
1) Worst case package.
2) Max number of outputs defined as (n). Data inputs are driven 0V to 5.0V, (n-1) outputs switching and one output at GND.
3) Max number of data inputs (n) switching. (n-1) switching 0V to 5.0V. Inputs under test switching: 5.0V to threshold (V_{ILD}), 0V to threshold (V_{IHD}), f=1MHz.

TEST CIRCUIT

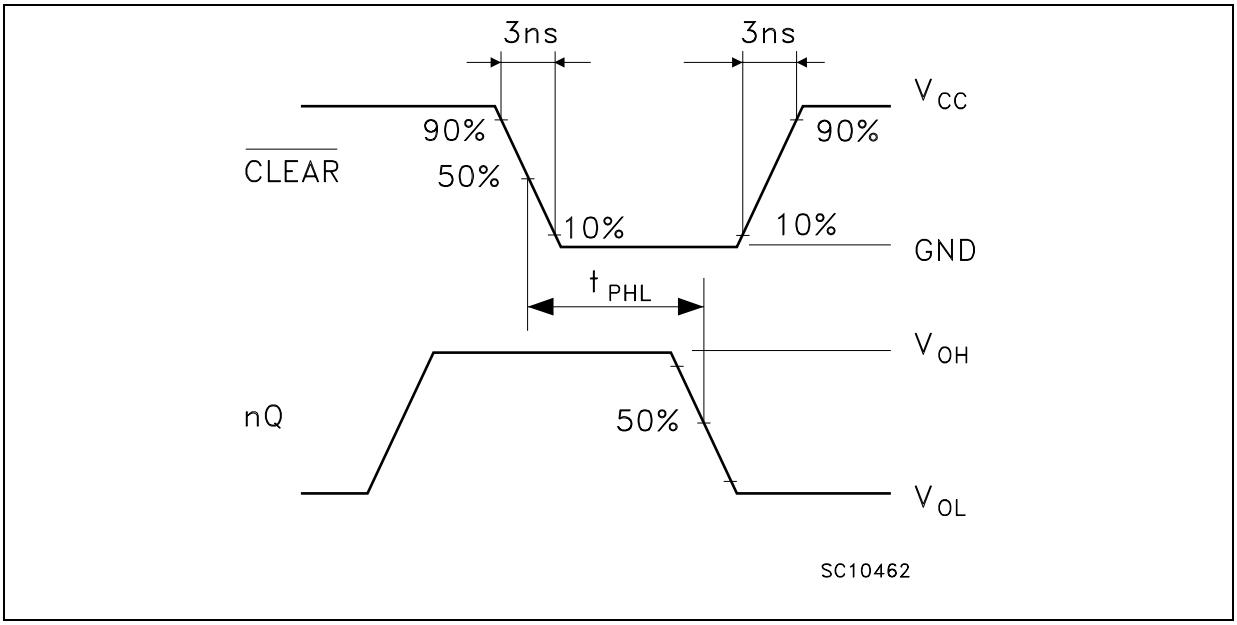


C_L =15/50pF or equivalent (includes jig and probe capacitance)
$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

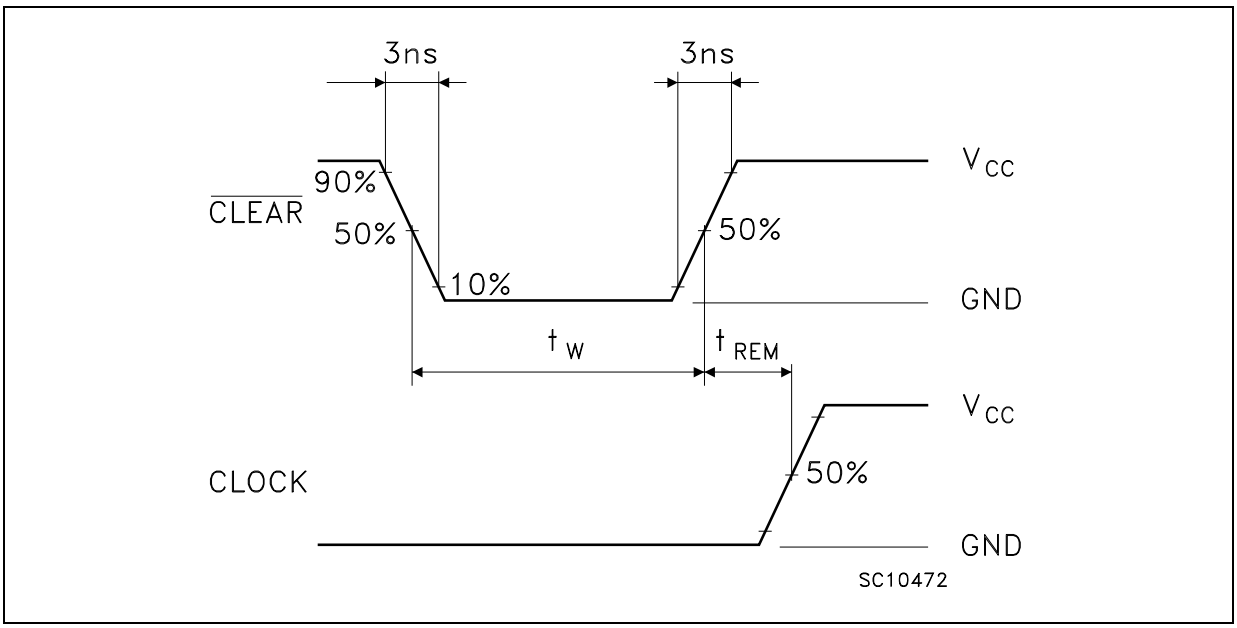
WAVEFORM 1: PROPAGATION DELAYS, SETUP AND HOLD TIMES (f=1MHz; 50% duty cycle)



WAVEFORM 2: PROPAGATION DELAYS (f=1MHz; 50% duty cycle)

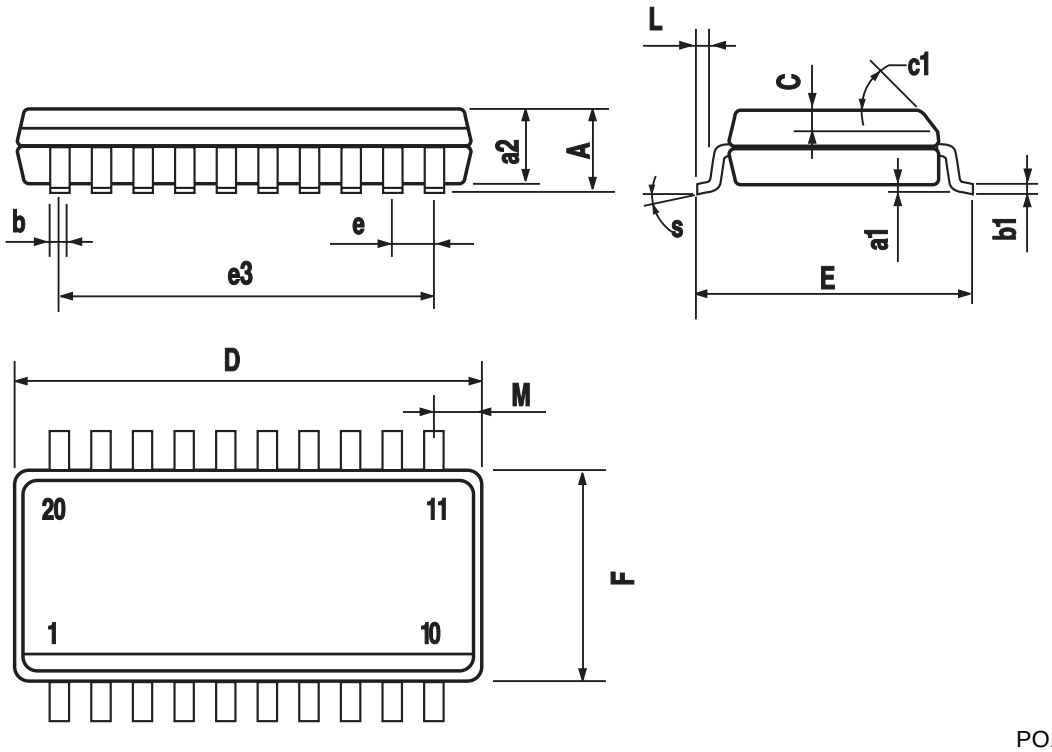


WAVEFORM 3: RECOVERY TIME (f=1MHz; 50% duty cycle)



SO-20 MECHANICAL DATA

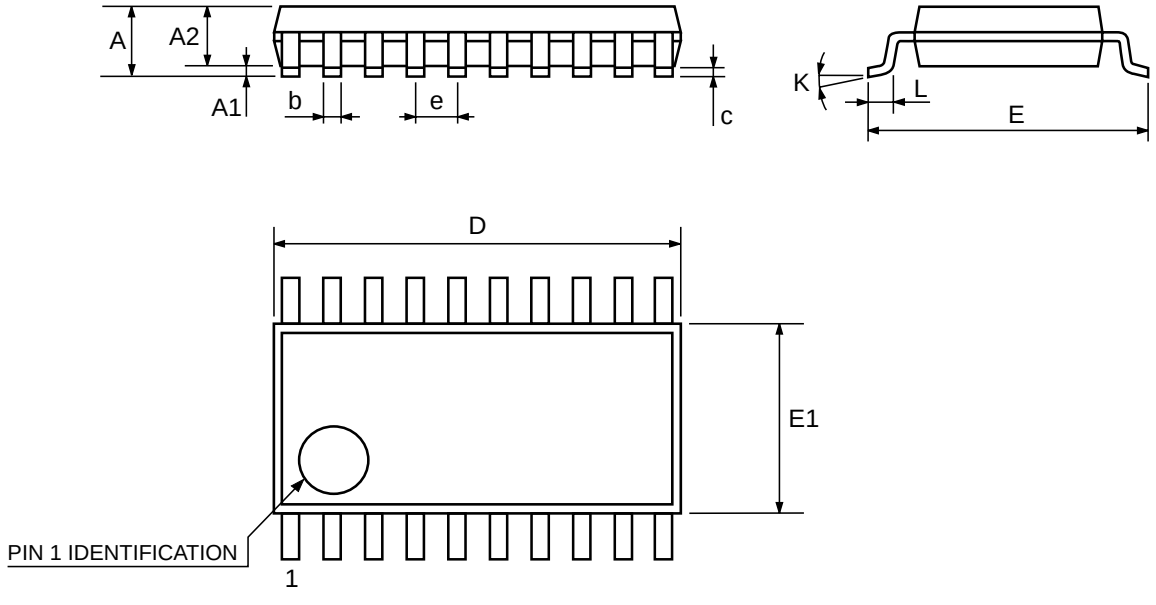
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			2.65			0.104
a1	0.1		0.2	0.004		0.008
a2			2.45			0.096
b	0.35		0.49	0.014		0.019
b1	0.23		0.32	0.009		0.012
C		0.5			0.020	
c1	45° (typ.)					
D	12.60		13.00	0.496		0.512
E	10.00		10.65	0.393		0.419
e		1.27			0.050	
e3		11.43			0.450	
F	7.40		7.60	0.291		0.300
L	0.50		1.27	0.020		0.050
M			0.75			0.029
S	8° (max.)					



PO13L

TSSOP20 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	6.4	6.5	6.6	0.252	0.256	0.260
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



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